

Product Specifications

Features

- Third Generation Field-Programmable Gate Array
 - Abundant flip-flops
 - Flexible function generators
 - No on-chip RAM
 - Dedicated high-speed carry-propagation circuit
 - Wide edge decoders (four per edge)
 - Hierarchy of interconnect lines
 - Internal 3-state bus capability
 - Eight global low-skew clock or signal distribution network
- Flexible Array Architecture
 - Programmable logic blocks and I/O blocks
 - Programmable interconnects and wide decoders
- Sub-micron CMOS Process
 - High-speed logic and Interconnect
 - Low power consumption
- Systems-Oriented Features
 - IEEE 1149.1-compatible boundary-scan logic support
 - Programmable output slew rate (2 modes)
 - Programmable input pull-up or pull-down resistors
 - 12-mA sink current per output
 - 24-mA sink current per output pair
- Configured by Loading Binary File
 - Unlimited reprogrammability
 - Six programming modes
- XACT Development System runs on '386/'486-type PC, Apollo, Sun-4, and Hewlett-Packard 700 series
 - Interfaces to popular design environments like Viewlogic, Mentor Graphics and OrCAD
 - Fully automatic partitioning, placement and routing
 - Interactive design editor for design optimization
 - 288 macros, 34 hard macros, RAM/ROM compiler

Description

The Xc4010D and XC4013D are RAM-less, lower-cost versions of the XC4010 and XC4013. They are identical to the XC4010 and XC4013 in all respects, except for the missing on-chip RAM.

The XC4010D and XC4013D are available in most of the same PLCC, PQFP, and PGA packages as their corresponding XC4000 non-D equivalents. See page 2-70 for details.

The XC4010D and XC4013D are also pin-compatible with the XC5210 (see XC5200 Data Sheet for additional information). The XC5210 provides another possible cost-reduction path for lower-performance applications that do not use the XC4000D features like wide-decoders and carry logic.

For complete electrical specifications, see pages 2-47 through 2-55.

For a detailed description of the device features, architecture and configuration methods, see pages 2-9 through 2-45.

For a detailed list of package printouts, please use the cross-reference on page 2-70.

For package physical dimensions and thermal data, see Section 4.

Table 1. The XC4000D Family of Field-Programmable Gate Arrays

Device	XC4010/10D	XC4013/13D
Approximate Gate Count	10,000	13,000
CLB Matrix	20 x 20	24 x 24
Number of CLBs	400	576
Number of Flip-Flops	1,120	1,536
Max Decode Inputs (per side)	60	72
Max RAM Bits	12,800*	18,432*
Number of IOBs	160	192

*XC4010D and XC4013D have no RAM

XC4000D Pinout Cross-Reference

Package	XC4010	XC4010D	XC4013	XC4013D	XC5210	Pinout page
84-pin PLCC	✓	✓			✓	PC84 on page 2-62
160-pin PQFP	✓	✓	✓	✓	✓	PQ160 on page 2-62
191-pin PGA	✓					PG191 on page 2-62
208-pin PQFP	✓	✓	✓	✓	✓	PQ208 on page 2-62
223-pin PGA			✓		✓	PG223 on page 2-64
225-pin BGA	✓	✓	✓	✓		BG225 on page 2-64
240-pin PQFP			✓	✓	✓	PQ240 on page 2-64

For additional information on the XC5210, please see the **XC5200 Product Description**.

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